Effect Temperature On Fluorine Doped Tin Oxide Via Spray Pyrolysis Technique.

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Abstracts.

The synthesis of fluorine doped tin oxide thin films were successfully deposited onto well cleared glass substrate by varying the deposition temperature. The XRD patterns of the films showed that the deposited films are polycrystalline in nature having the characteristic peaks of tetragonal structure of SnO_2.The peaks observed are (110), (101), (200), (211) and the preferential growth along the (110) direction. The current versus voltage plots of the material deposited with 380^0C, 390^0C and 400^oC, which represent sample FT4-FT6 showed a non-linear plot. It was observed to be non Ohmic semiconducting material. It was also noticed that as the temperature of the depositing material increases the thickness of the films increases. The resistivity of the material deposited decreases as the temperature and thickness of the films increases. It was observed that as the optical absorbance and reflectance decreases the wavelength of the incident radiation increases and transmittance increases as the wavelength of the incident radiation increases. The films deposited at 380^0C, 390^0C and 400^oC recorded energy gap of 2.6eV-3.0eV.

Keys words: Spray Pyrolysis, Fluorine, Tin Oxide, XRD and Optical Properties

1. Introduction

Thin films Semiconductor have been studied for many years because of their importance in various fields like solar cells and gas sensors [1-4]. Transparent conductive oxides of high band gap semiconductors are mechanically hard and can withstand high temperatures. Also wide and direct

band gap semiconductor materials are of much interest for blue and ultraviolet (UV) optical devices, such as light-emitting diodes and laser diodes [5-7]. Tin oxide based thin films are good candidate for a number of applications in many fields of research and in various optoelectronic device fabrications [9]. Most important is the thin film application in environmental monitoring through sensing of a number of gases [10]. Tin oxide characteristics for gas sensing applications have been improved through catalytic and impurity doping with a view of improving on its sensitivity to a number of gases as well as its optoelectronic properties [11-12]. Tin oxide based thin films have been reported to suffer from sensitivity due to the presence of ambient humidity which has been overcome by resistive heating of the thin film gas sensor element [13]. Tin oxide is a wide band gap, non-stoichiometric semiconductor material of n-type conductivity. The conductivity of SnO_2 thin films can be manipulated from normal to degenerate by suitably doping SnO_2 with appropriate amount of halogens [11, 14]. Low electrical resistivity and high visible transmittance are the key elements for solar cell layers, gas sensors, hybrid microelectronics and opto-electronic devices [15]. SnO_2:F coatings can also act as heat mirrors due to their high reflectivity in the infrared range. Among the various transparent conducting oxides, tin oxide (TO) films doped with fluorine or antimony are most promising due to their chemical inertness and mechanical hardness along with low electrical resistivity and good optical transmittance. Tin oxide is the first transparent conductor to have received significant commercialization [16]. The application of thin films in modern technology is widespread. The methods employed for thin-film deposition can be divided into two groups based on the nature of the deposition process viz., physical or chemical. The physical methods include physical vapour deposition (PVD), laser ablation, molecular beam epitaxy, and sputtering. The chemical methods comprise gas-phase deposition methods and solution techniques. The gas-phase methods are chemical vapour deposition (CVD) and atomic layer epitaxy (ALE), while spray pyrolysis, sol-gel, spin and dip-coating methods employ precursor solutions [17]. Among the various deposition techniques, the spray pyrolysis is well suited for the preparation of doped tin oxide thin films because of its simple and inexpensive experimental arrangement, ease of adding various doping material, reproducibility, high growth rate, and mass production capability [16]. Spray pyrolysis is a processing technique being considered in research to prepare thin and thick films, ceramic coatings, and powders. Unlike many other film deposition techniques, spray pyrolysis represents a very simple and relatively cost-effective processing method (especially with regard to equipment

costs). It offers an extremely easy technique for preparing films of any composition. It does not require high-quality substrates or chemicals. The method has been employed for the deposition of dense films, porous films, and for powder production. Even multi layered films can be easily prepared using this versatile technique. Spray pyrolysis has been used for several decades in the glass industry and in solar cell production [17]. Typical spray pyrolysis equipment consists of an atomizer, precursor solution, substrate heater, and temperature controller. The following atomizers are usually used in spray pyrolysis technique: air blast (the liquid is exposed to a stream of air) [18], ultrasonic (ultrasonic frequencies produce the short wavelengths necessary for fine atomization) and electrostatic (the liquid is exposed to a high electric field) [19].

Experimental Details

2.1 Materials And Methods

The various materials were used in the fabrication of the films; Glass substrate, Spray pyrolysis machine, Ethanol and water as solvent, Precursor $SnCl_4$ (MERCK), Dopant Ammonium fluoride (BDH), Four-point probe, X-ray diffractometer and UV visible spectrophotometer. Spray pyrolysis technique was used for this deposition. It involves spraying of a solution containing soluble salts of the desired compound onto heated substrates, where the constituents react to form a chemical compound. The chemical reactants used for making solution are selected such that the products other than the desired compound are volatile at the temperature of deposition. Every sprayed droplet reaching the surface of the hot substrate undergoes pyrolytic decomposition and forms a single crystalline or cluster of crystallites as a product. The other volatile by-products and solvents escape in the vapour phase. The substrates provide thermal energy for the thermal decomposition and subsequent recombination of the constituent species.
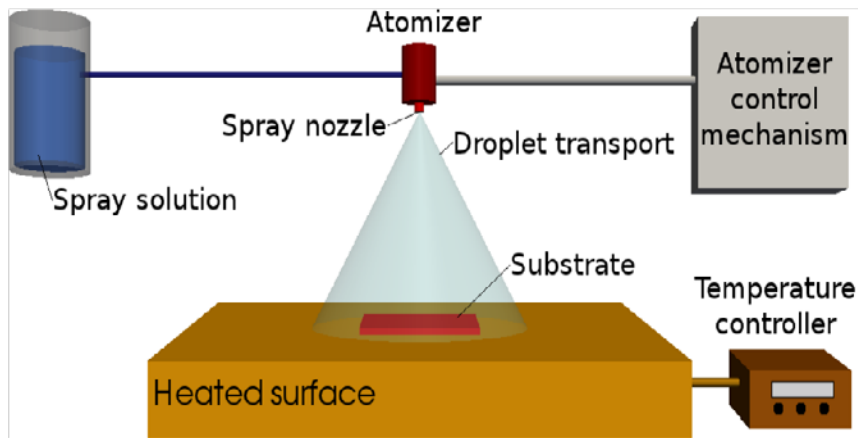
Figure 1: General schematic of a spray pyrolysis deposition process.

2.2 Substrate (Microscopic Glass Substrate)

The substrate used here is a microscopic glass substrate. Hand gloves were used to handle the substrates to avoid contamination. The substrates were dipped in acetone, methanol, rinsed with distilled water and later ultra-sonicated for 30 min in acetone solution after which they were rinsed in distilled water and kept in an oven at 333K to dry.

2.3 Spray Process/Procedure

The spray process involves optimization of several process parameters. The values of the optimized process parameters are: Precursor flow rate 0.07ml/min, Solvent 90% ethanol, Precursor ($SnCl_4$) concentration 0.1mol, Dopant Ammonium Fluoride, Dopant concentration (0.1mol), Spray-nozzle specification: outside diameter: 0.34mm. Internal diameter 0.18mm, Spray nozzle to substrate distance: 8mm, Substrate temperature were 380^0C, 390^0C and 400^oC with Atomizing voltage 3.8KV

2.4 Experimental Procedure

Thin films of fluorine doped thin oxide were deposited on a transparent glass substrate using $SnCl_4$ dissolved in 90ml of ethanol and 10ml of water. The $SnCl_4$ was used as source of Sn while NH_4F as the source of doping impurities. During the deposition, the films were deposited at a constant dopant concentration and voltage rate of 10% and 3.8KV respectively. The substrate was attached

to the substrate holder, with the temperature regulator; the substrate was heated to the temperature at which that particular sample will be deposited. The voltage was set to 3.8KV via the voltage knob and the precursor solution of $SnCl_4$ and NH_4F was passed through the nozzle pump direct to the nozzle. As the mixture gets to the substrate through the nozzle and hits the surface of the substrate, evaporation of the residual solvent takes place, spreading of the droplet and then the salt decomposition SnO_2: F was finally deposited on the substrate. Film uniformity was ensured by moving both the nozzle (needle) and the substrate. Different levels of doping were achieved by varying the amount of NH_4F in the precursor solution from 0.1 to 0.3M. The films with different level of doping were deposited on the glass substrate at different temperature (see table 1). Uniformity of temperature over the entire substrate and fine sprays were necessary to obtain good quality films which are reproducible. The temperature during spray were 380^0C, 390^0C and 400^oC with the help of the temperature controller whereas the dopant concentration of NH_4F was kept constant (see table 1). After spraying, the substrates were allowed to be cooled at room temperature.

Table 1: Variations of Temperature Parameters For Fabrication.

Samples	Dopant NH$_4$F (%)	SnCl$_4$ (ml)	Ethanol (ml)	Voltages (KV)	Temperature (Degree)
FT4	10	20	5	3.8	380
FT5	10	20	5	3.8	390
FT6	10	20	5	3.8	400

2.5 Characterization Of Fabricated Films.

The fabricated films were characterized using three different instruments for the analysis. The optical analysis were carried out using MT670 UV- visible spectrophotometer where the absorbance of each of the samples was obtain and other optical properties were obtained by calculation. Electrical (I/V) characterization of thin films was done using the four-point probe method at room temperature. The measurements were taken in a square geometry using Keithley 2400 Source Meter. This was carried out at Sheda Science and Technology Complex, Abuja. The

structural characterization of the films was carried out using cu-kal (λ = 1.15418Å) DD-15.5 standard diffractometer, the instrument helped in determining the type of crystal lattice and intensities of diffraction peaks, with the help of data base software supplied by the international center of diffraction data. The characterization was carried out at IThemba LABS Materials Research Department South Africa.

Results And Discussion

3.1 Structural Analysis

The XRD analysis was carried out to determine the phase angel, crystallite size and dislocation density of the films deposited by varing the deposition temperature of the films., deposition voltage, dopant concentration were kept constant. The XRD patterns of the films prepared by different deposition parameters showed that the deposited films are polycrystalline in nature having the characteristic peak of tetragonal crystal structure. The peaks observed are (110), (101), (200), (211) (see table 2) and among all the peaks the orientation of (110) peak is the highest intensity peak. This is observed in the patterns of all the films with different deposition parameters of SnO_2:F films prepared from $SnCl_4$ precursor, which also revealed the preferential growth along the (110) direction. The crystallite sizes of the deposited SnO_2:F films were determined from Scherer's equation (1) [20].

$$D = \frac{0.94\lambda}{\beta Cos\theta} \qquad (1)$$

where D is the crystallite size in nanometers, β is the full width at half maximum of the diffraction line measured in radians and λ is the wavelength of X-ray used (λ= 1.5418Å). The dislocation density δ is calculated using equation 2 [21-22]. See Figure 2 for the XRD pattern

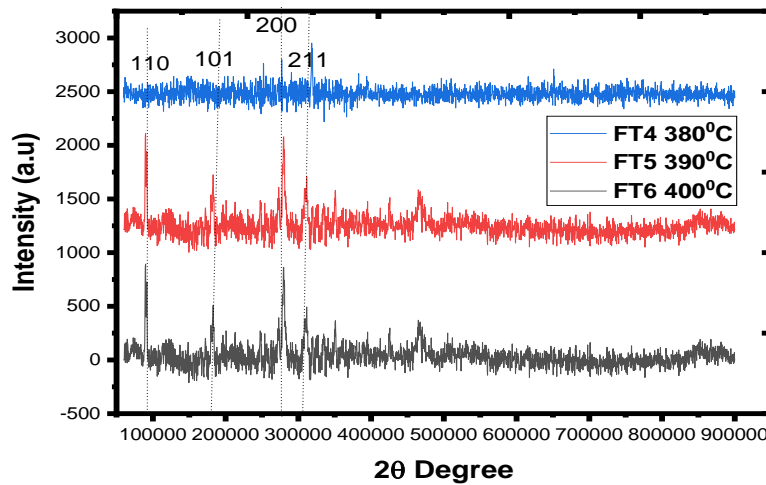$$\delta = \frac{1}{D^2} \text{ lines/m}^2 \qquad (2)$$

Figure 2: XRD pattern of SnO$_2$:F

Table 2: Structural parameters of fluorine doped tin oxide

Sample/ Thickness	2θ (degree)	d (spacing) Å	(β) FWHM	(hkl)	Lattice (a) Å	Grain Size(D) nm	Dislocation density (δ) x10^{11} lines/m^2
FT4/	10.0087	3.430	0.0642	110	4.7309	18.7721	2.8378
171.229nm	20.0332	3.428	0.0642	101		18.9900	2.7730
	30.0543	3.397	0.0642	200		19.3627	2.6673
	32.0867	3.378	0.0642	211		19.4584	2.6411
FT5/	10.0054	3.440	0.0642	110		22.6609	1.9473
171.229nm	19.0756	3.434	0.0642	101		22.8911	1.9084
	29.0870	3.321	0.0642	200		23.3231	1.8383
	31.0321	3.409	0.0642	211		23.4285	1.8218
FT7/							
	10.3256	3.294	0.0291	110		50.0067	3.9989
192.609nm	20.2987	3.285	0.0291	101		50.5956	3.9064
	30.1943	3.265	0.0291	200		51.5843	3.5515
	37.2872	3.243	0.0291	211		52.5620	3.6100

3.2 Electrical Analysis

Electrical characterization of thin films was done using the four-point probe method at room temperature. The measurements were taken in a square geometry using Keithley2400 Source

Meter. From (fig. 3 and table 3) the current versus voltage plots of the material deposited with 380^0C, 390^0C and 400^oC, which represent sample FT4-FT6 showed a non-linear plot. It was observed to be non Ohmic semiconducting material. It was also noticed that as the temperature of the depositing material increases the thickness of the films increases. The resistivity of the material deposited decreases as the temperature and thickness of the films increases. The electrical conductivity of the material deposited increases with respect to the temperature and thickness respectively [23-24].

Table 3: Calculated values of resistivity and conductivity

Samples	Thickness, t (nm)	Resistivity, ρ (Ωm)	Conductivity, σ (Ωm)$^{-1}$
FT4 (3800C)	171.229	7.4006x106	1.3512x10-7
FT5 (3900C)	174.657	2.0449x105	4.8902x10-6
FT6 (400^0C)	178.701	1.0802×10^5	9.2575×10^{-6}
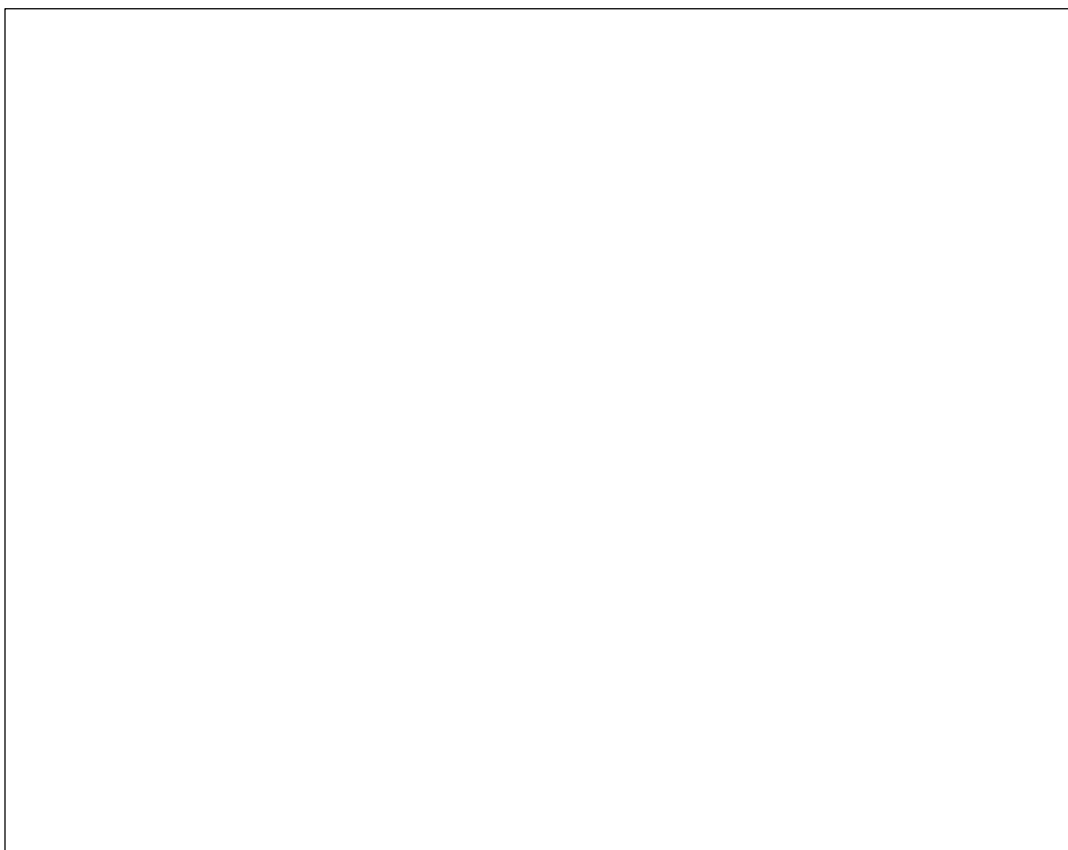
Figure 3: Current versus Voltage plot of sample FT74-FT6

3.3 Optical Properties

Optical characterization of the thin films was done using the UV-visible spectrophotometer from (fig.5) it was observed that as the optical absorbance decreases the wavelength of the incident radiation increases. It was noticed that sample FT6 deposited at 400^0C recorded the highest absorbance with absorbance value of 0.310 at incident wavelength of 880nm. The sample FT4 deposited at 380^0C with absorbance value of 0.234 at incident wavelength of 320nm, hence, it is very clear that sample FT5 deposited at 390^0C recorded absorbance value of 0.244 at incident wavelength of 420nm. Therefore, the optical absorbance of the deposited material decreases as the wavelength of the incident radiation increases but has no regular pattern with the temperature [11,35-40]. From (fig.6) it was observed that as the optical transmittance increases as the wavelength of the incident radiation increases. It was noticed that sample FT5 deposited at 390^0C emerged the highest transmittance with transmittance value of 0.916% at incident wavelength of 1480nm followed by sample FT4 deposited at 380^0C with transmittance value of 0.780% at incident wavelength of 1480nm. It was observed that sample FT6 deposited at 400^0C recorded the lowest transmittance value of 0.569% at incident wavelength of 1480nm. Therefore, the optical transmittance of the deposited material increases with the wavelength of the incident radiation [25, 33-37]. From (fig.7). It was noticed that sample FT6 deposited at 400^oC emerged the highest reflectance with reflectance value of 0.200% at incident wavelength of 880nm and stable followed by sample FT5 deposited at 390^0C with reflectance value of 0.186% at incident wavelength of 420nm. Hence, it is very clear that sample FT4 deposited at 380^0C emerged the lowest with reflectance value of 0.182% at incident wavelength of 640nm. Therefore, the optical reflectance of the deposited material decreases as the temperature of the deposited material (SnO_4:F) increases with the wavelength of the incident radiation [25, 34-38].
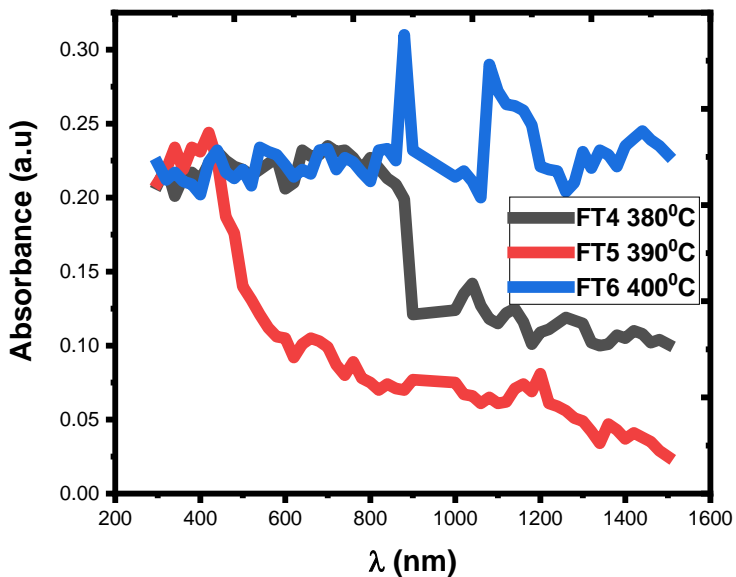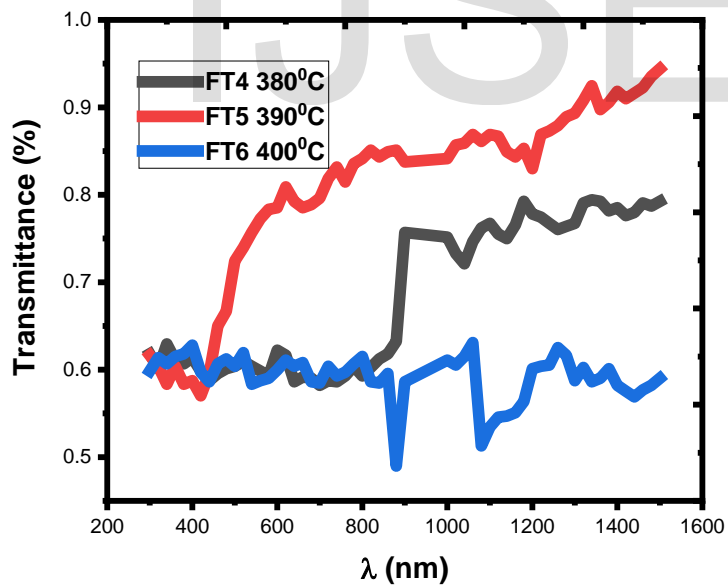
Figure 4: The optical absorbance versus wavelength

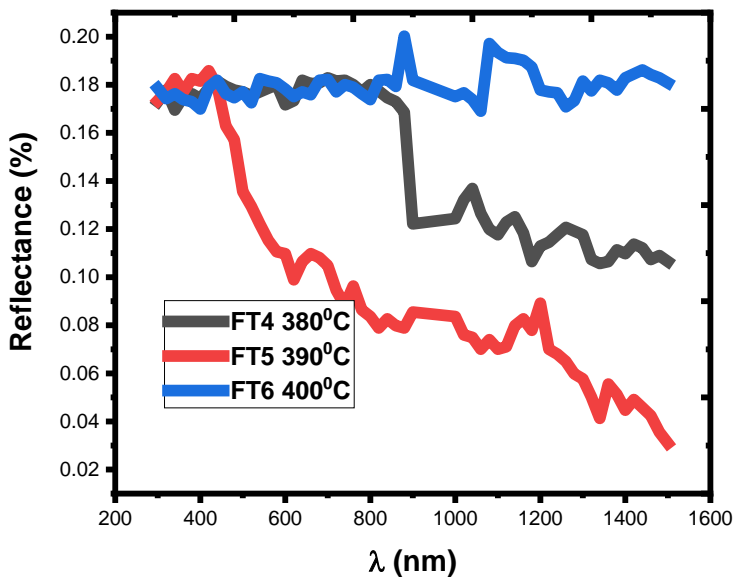Figure 5: The optical transmittance versus wavelength

Figure 6: The optical reflectance versus wavelength

The band gap energy of the deposited material was obtained using

$$\alpha h v = A(h v - E_g)^n$$

Where A is a constant, E_g is the energy band gap of the material deposited (F: SnO_4), h is the planks constant and $n = \frac{1}{2}$ for direct allowed transition. This relation establishes that aplot of $(\alpha h v)^2$ versus $h v$ produces a linear pattern the intercept on $h v$ axis being the energy band gap, E_g of the thin film. The plot is not direct [26, 36-40]. The extrapolations of the direct portions of plots to the energy axis give the band gap energy. From (fig.7) which represents the material deposited at 10conc.-30conc. Recorded energy band gap of 2.6eV-3.0eV.
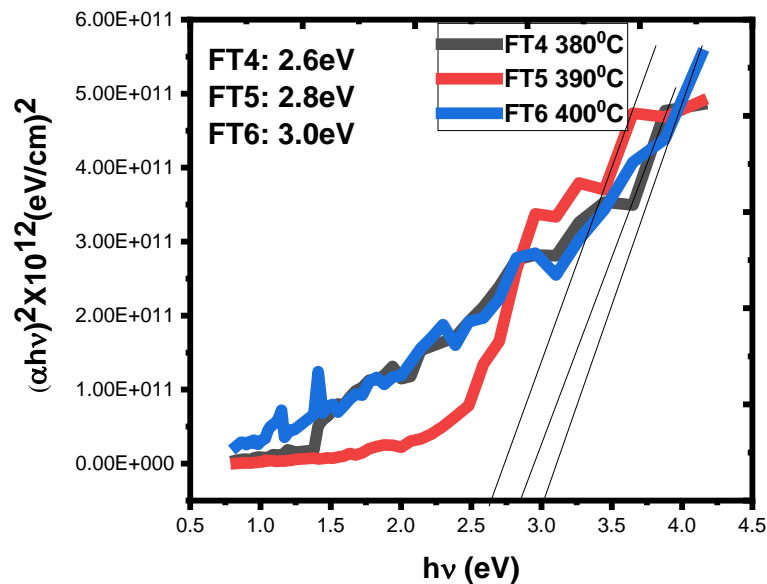
Figure 7: The absorption coefficient square versus photon energy FT7

From (Fig. 8), shows that as the optical refractive index value is steady as the photon energy increases. It was noticed that sample FT6 deposited at 400^0C emerged the highest refractive index with refractive index value of 2.6196 followed by sample FT5 deposited at 390^0C with refractive index value of 2.5154. Hence, sample FT4 deposited at 380^0C emerged the lowest with refractive index value of 2.4870. Therefore, the optical refractive index of the deposited material decreases as the temperature of the deposited material (SnO_4:F) decreases with increase in the photon energy [11]. From (fig. 9) it was observed that the extinction coefficient maintained a steady value for sample FT6 and FT4 after a sharp increase and increases for sample FT5 as the photon energy increases. It was noticed that sample FT6 deposited at 400^0C recorded the highest extinction value of 0.02466, sample FT5 deposited at 390^0C with extinction coefficient value of 0.01941 followed by sample FT4 deposited at 380^0C with extinction coefficient value of 0.01881. Hence, the extinction coefficient of the deposited material increases as the deposition temperature of the deposited material (SnO_4:F) increases with the photon energy [27,36-40]. From (Fig.10) shows that as the optical conductivity increases with the photon energy. It was noticed that sample FT6 deposited at 400^0C emerged the highest with optical conductivity value of 4.3716E+13 followed by sample FT5 deposited at 390^0C with optical conductivity value of 4.0555E+13 and sample FT4

deposited at 380^0C recorded optical conductivity value of 4.0453E+13 Hence, the optical conductivity of the deposited material increases as the temperature of the deposited material (SnO4:F) increases with the photon energy [11,28-35].
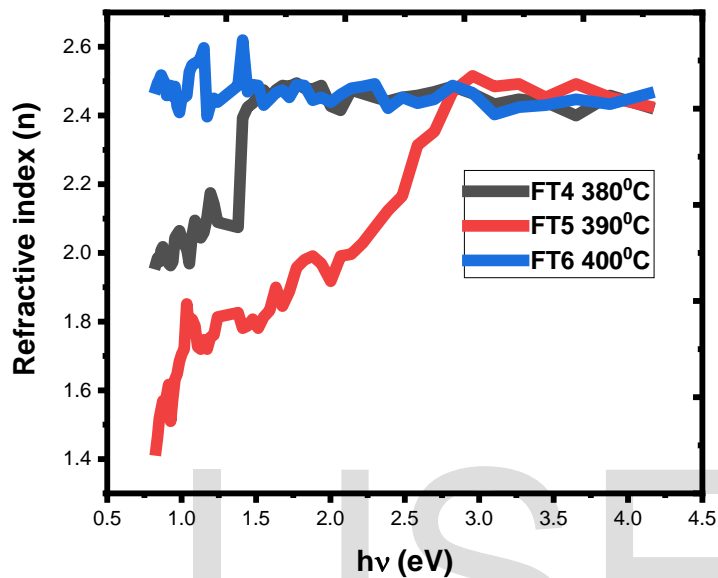

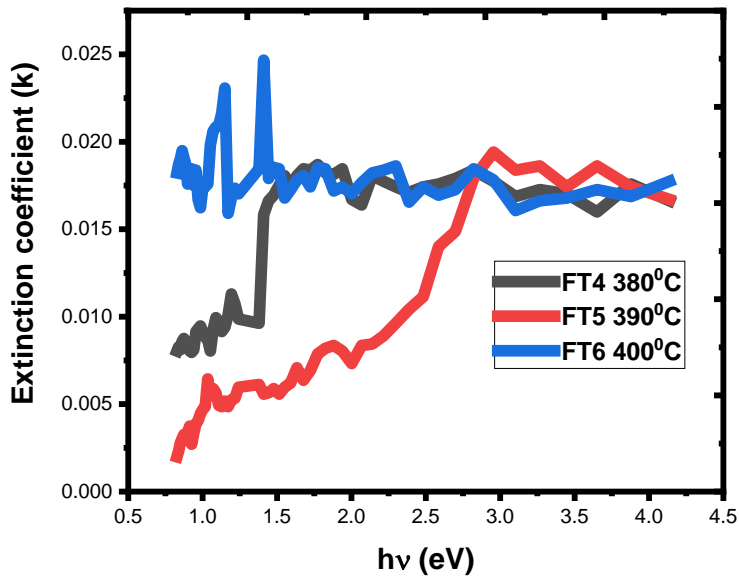Figure 8: The refractive index versus photon energy

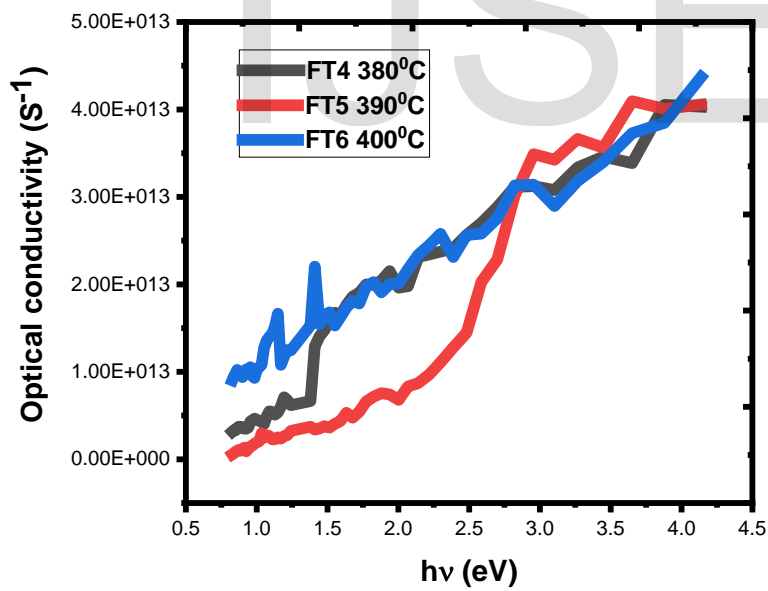Figure 9: The extinction coefficient versus photon energy

Figure 10: The optical conductivity versus photon energy

Conclusion

Fluorine doped tin oxide thin films have been successfully deposited and characterized at different deposition parameters. The absorbance, reflectance decreases and transmittance of the films increases as the wavelength of the films increases with incident radiation. It was observed that as the voltage of the films increases the thickness of the films increases. The conductivity of the films was observed to be increasing with decrease in voltage.

Acknowledgement

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